

i.MX25 PDK

Windows® Embedded CE 6.0

Demo Image Readme

This document contains important information about the package contents and flashing procedures.

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1 Release Contents

This is a release of the Freescale Semiconductor i.MX25 3-Stack Windows Embedded CE 6.0 SDK.

1.1 Supported Hardware

This package supports the i.MX25 3-Stack Rev 1.1 board.



1.2 Supported Features in this Release

Audio Player:

- MP3
- AAC
- WMA
- m4a (ACC) (MP3)

PCM encoding:

- MP3

Drivers

- ADC
- Audio (SGTL5000)
- Backlight
- Camera
- CAN 1
- CSPI 1
- Display VGA
- FEC
- GPT 1
- I2C
- Keyboard US
- SDHC1
- SERIAL
- Touch
- USB OTG
- USB Host
- NAND Storage

Apps

- ping
- ipconfig
- route

- Console window
- Camapp
- ETCHA
- SwitchUSB2MSC
- SwitchUSB2RNDIS
- SwitchUSB2SERIAL

1.3 Release Contents

The following table identifies the components of the 3-Stack hardware kit.

3-Stack Demo Image Package Component	Description
XLDR.nb0	NAND boot loader binary
XLDR.bin	NAND boot loader image
EBoot.nb0	NAND EBOOT binary
Eboot.bin	NAND EBOOT image
NK.nb0	NAND OS Kernel binary
NK.bin	NAND OS Kernel image
pdk2009_12_imx25_WinCE60_DemoImage_ReadMe.pdf	This file.

2 Flashing Procedures

For the step-by-step description of the flashing procedures, see Chapter 5 of the *i.MX25 PDK Windows Embedded CE 6.0 User's Guide*.

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